



*DRW*

Docket No.: M4065.0248/P248-C  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Allen McTeer

Application No.: 10/656,182

Confirmation No.: 8422

Filed: September 8, 2003

Art Unit: 2815

For: A MULTI-LAYERED COPPER BOND PAD  
FOR AN INTEGRATED CIRCUIT

Examiner: E. Lee

**REQUEST FOR RECONSIDERATION**

MS AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated November 3, 2006, finally rejecting claims 74-80, 82 and 83, please reconsider the above-identified U.S. patent application in light of the following remarks.

*do not enter*  
*BL*  
*1/25/07*